



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chien-Chao Huang, et al.

Serial No.: 10/710,012

Filed:

June 11, 2004

For:

Improved Cobalt Silicidation Process for

Substrates with a Silicon Germanium Layer §

Docket No.: 2001.1531 / 24061.439

Examiner:

To Be Determined

Art Unit:

2811

Conf. No.:

4011

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In compliance with the duty of disclosure under 37 CFR §1.56, and in accordance with the practice under 37 CFR §1.97 and §1.98, the Examiner's attention is directed to the documents listed on the enclosed modified Form PTO-1449. No inference should be made that the cited references are in fact material, are in fact prior art, or that no better art exists.

The above-identified application was filed after June 30, 2003. Therefore, pursuant to the waiver of the requirement under 37 CFR 1.98 (a)(2)(i) as stated in a Pre-OG Notice dated July 11, 2003, copies of the U.S. patents listed on the enclosed modified Form PTO-1449 are not being provided.

This Information Disclosure Statement is being filed within three months of the United States filing date or before the mailing date of a first Office Action on the merits. No certification or fee is required (37 CFR §1.97(b)).

It is respectfully requested that the above information be considered by the Examiner and that a copy of the enclosed Form PTO-1449 be returned indicating that such information has been considered.

Respectfully submitted,

David M. O'Dell

Registration No. 42,044

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service, via First Class Mail to Mail Stop: Patent Application, Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the February 15, 2005.

Name

Date: <u>February 15, 2005</u>

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Facsimile: 214-200-0853

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In place of U. S. DEPARTMENT OF COMMERCE PTO 49 PATENT AND TRADEMARK OFFICE Form

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

SHEET

OF

Complete if Known			
Application Number	10/710,012		
Filing Date	June 11, 2004		
Applicant(s)	Chien-Chao Huang, et al.		
ArtiUnit	2811		
Examiner Name	TBD		
Attorney Docket Number	2001.1531 / 24061.439		

U. S. PATENT DOCUMENTS						
Examiner's	Cite No.	Document Number	Publication Date	Name of Patentee or Applicant of Cited Document		
,	AA	5,516,724	05-14-1996	Ast, et al.		
	AB	5,624,869	04-29-1997	Agnello, et al.		
	AC	6,117,723	09-12-2000	Huang		
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	AE	6,214,679	04-10-2001	Murthy, et al.		
	AF	6,376,342	04-23-2002	Tseng		
	AG	6,475,869	11-05-2002	Yu		

FOREIGN PATENT DOCUMENTS							
Examiner's Initials	Cite No.	Foreign Patent Document (Country Code – Number – Kind)	Publication Date	Patentee or Applicant of Cited Document	Translation		

OTHER PRIOR ART				
Cite No.				
АН	GLUCK, M., et al., "CoSi ₂ and TiSi ₂ for Si/SiGe Heterodevices", Elsevier Science S.A., Thin Solid Films 270, 1995, pages 549-554.			
Al	KRIVOKAPIC, Z, et al., "Nickel Silicide Metal Gate FDSOI Devices with Improved Gate Oxide Leakage", IEEE, 2002, 0-7803-7469-X/02, 4 pages.			
AJ	NAYAK, D. K., et al., "Enhancement-Mode Quantum-Well Ge _x Si _{1-x} PMOS, IEEE Electron Device Letters, Vol. 12, No. 4, April 1991, pages 154-156.			
AK	XIANG, QI, et al., "Strained Silicon NMOS with Nickel-Silicide Metal Gate", 2003 Symposium on VLSI Technology Digest of Technical Papers, 4-89114-035-6/03, 2 pages.			
AL	YEO, YEE-CHIA, et al, "Enhanced Performance in Sub-100 nm CMOSFETs Using Strained Epitaxial Silicon-Geramanium", IEDM, pages 753-756.			
	AH AI AJ AK			

		<u></u>
Examiner	Date	
Signature	Considered	

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.